

BFP196W

Low Noise Silicon Bipolar RF Transistor

- For low noise, low distortion broadband amplifiers in antenna and telecommunications systems up to 1.5 GHz at collector currents from 20 mA to 80 mA
- Power amplifier for DECT and PCN systems
- $f_{\rm T}$ = 7.5 GHz, $NF_{\rm min}$ = 1.3 dB at 900 MHz
- Pb-free (RoHS compliant) and halogen-free package with visible leads
- Qualification report according to AEC-Q101 available



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFP196W	Rls	1 = E	2 = C	3 = E	4 = B	-	-	SOT343

Maximum Ratings at T_A = 25 °C, unless otherwise specified

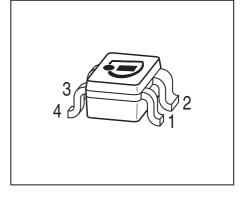
Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	12	V
Collector-emitter voltage	V _{CES}	20	
Collector-base voltage	V _{CBO}	20	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	150	mA
Base current	l _B	15	
Total power dissipation ¹⁾	P _{tot}	700	mW
_7 _S ≤ 69°C			
Junction temperature		150	°C
Ambient temperature	T _A	-65 150	
Storage temperature	T _{Stg}	-65 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	115	K/W

 ${}^{1}T_{S}$ is measured on the collector lead at the soldering point to the pcb

²For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)





Parameter	Symbol	Values			Unit
		min.	typ.	max.]
DC Characteristics				•	
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
<i>I</i> _C = 1 mA, <i>I</i> _B = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{\rm CE}$ = 20 V, $V_{\rm BE}$ = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
V _{CB} = 10 V, <i>I</i> _E = 0					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified



Parameter	Symbol		Values		Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	1			
Transition frequency	f _T	5	7.5	-	GHz
<i>I</i> _C = 70 mA, <i>V</i> _{CE} = 8 V, <i>f</i> = 500 MHz					
Collector-base capacitance	C _{cb}	-	0.86	1.3	pF
$V_{\rm CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.4	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	3.9	-	
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,					
collector grounded					
Minimum noise figure	NF _{min}				dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
<i>f</i> = 900 MHz		-	1.3	-	
<i>f</i> = 1.8 GHz		-	2.3	-	
Power gain, maximum available ¹⁾	G _{ma}				
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
<i>f</i> = 900 MHz		-	19	-	
<i>f</i> = 1.8 GHz		-	12.5	-	
Transducer gain	S _{21e} ²				dB
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 900 MHz		-	13	-	
<i>f</i> = 1.8 GHz		-	7	-	
Third order intercept point at output ²⁾	IP ₃	-	32	-	dBm
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 0.9 GHz					
1dB Compression point at output	P _{-1dB}	-	19	-	
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
<i>f</i> = 0.9 GHz					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified

 ${}^{1}G_{\text{ma}} = |S_{21} / S_{12}| (k - (k^{2} - 1)^{1/2})$

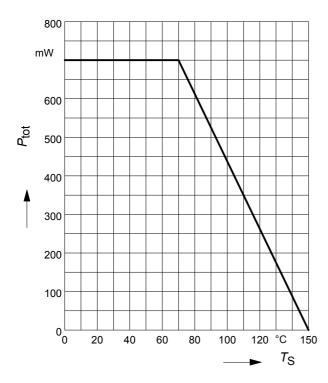
 2 IP3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.2 MHz to 12 GHz



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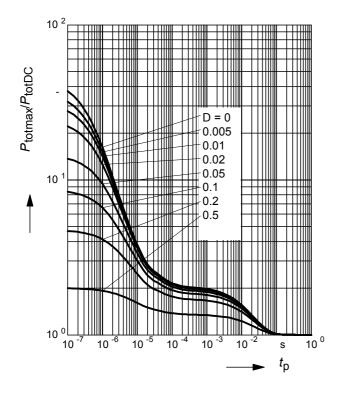
Total power dissipation $P_{tot} = f(T_S)$

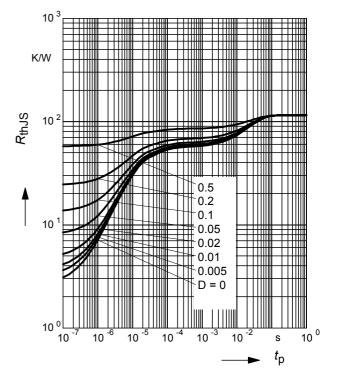
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



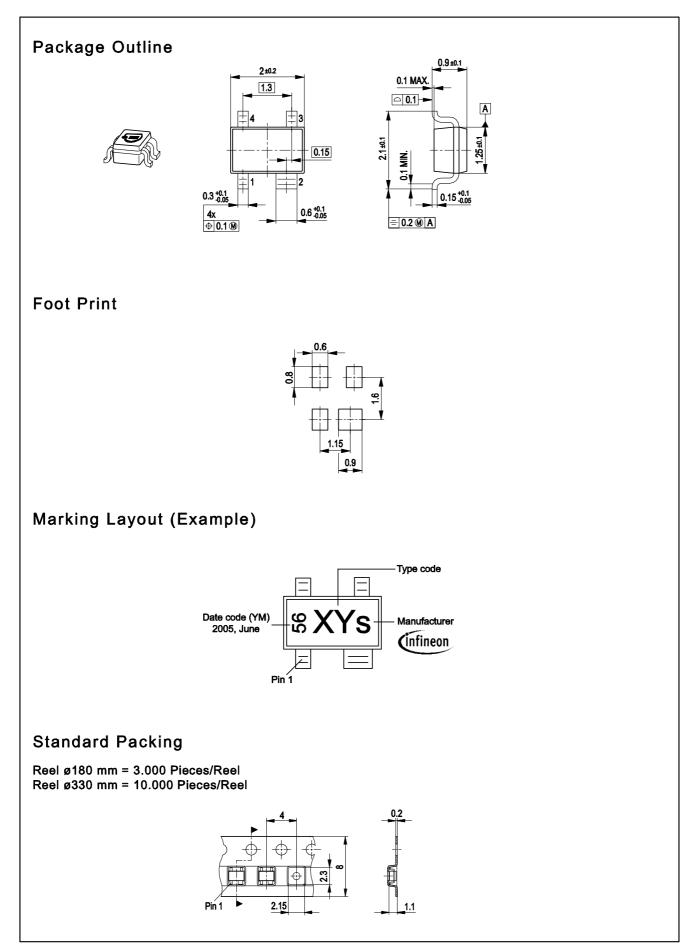
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$











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